



Product Change Notification

113061 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113061 - 00
Change Title: Intel® Server System R1304BB4GS9
PCN 113061-00, Product Design
Update System PSU Bracket and Add Mylar
Bumper
Date of Publication: June 13, 2014

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	Jun 28, 2014
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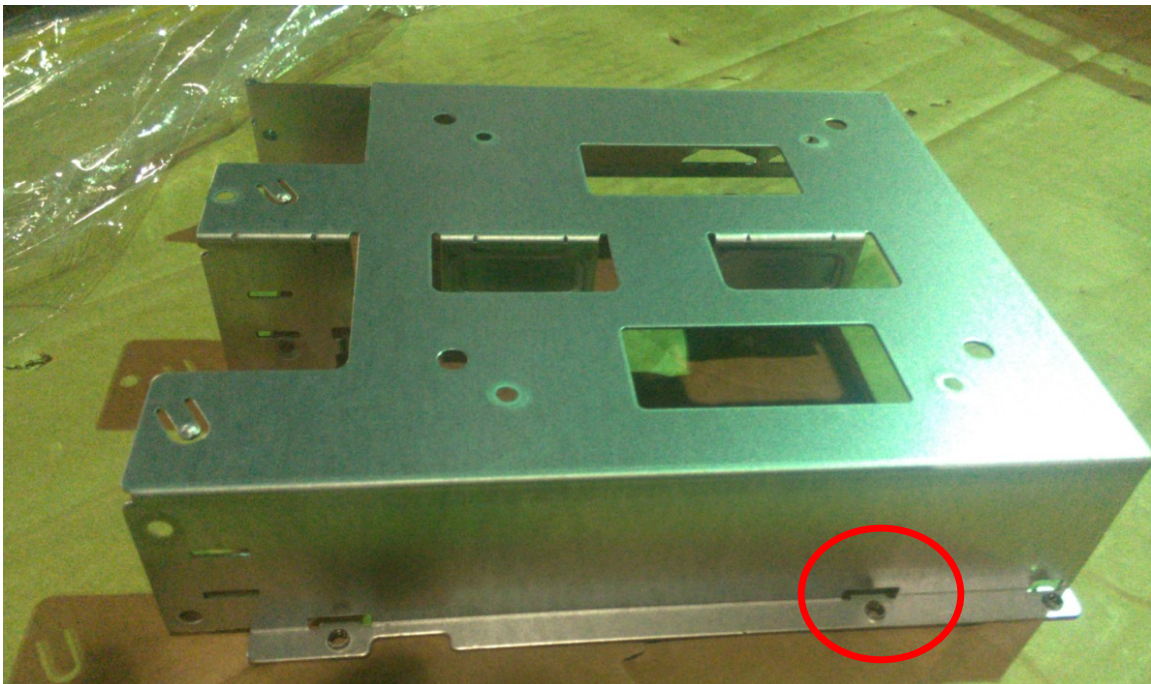
** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

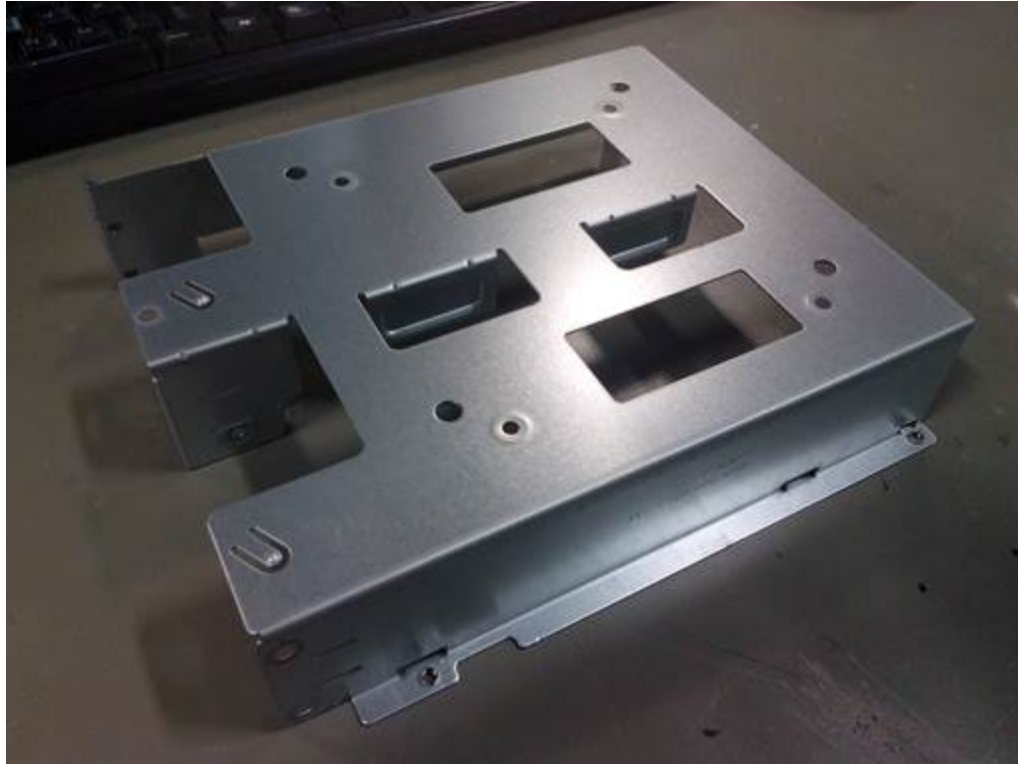
Intel is implementing the following changes on Intel® Server System R1304BB4GS9:

1. Update the Power Supply bracket by removing the middle punch. Please refer to the following pictures for details:

Pre-change:



Post-change:



2. Add a mylar bumper on the side of the DVDROM bay to improve the fit of the DVDROM mechanical assembly. See image below:



Example of the mylar bumper on the side of the DVDROM bay

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from this change, but encourages customers to understand the change and determine the impact to their applications.

Products Affected / Intel Ordering Codes:

ASMO SKU			
Product Code	MM#	Pre Change TA	Post Change TA
R1304BB4GS9	922000	G61997-002	G61997-003

PCN Revision History:

Date of Revision:

June 13, 2014

Revision Number:

00

Reason:

Originally Published PCN